



Mini-spectrometer

TG series

C11118GA

Long-wavelength type (to 2.55 μ m) near-infrared mini-spectrometer

HAMAMATSU TG series mini-spectrometers are polychromators integrated with optical elements and an image sensor. Light to be measured is guided into the entrance port of TG series through an optical fiber and the spectrum measured with the built-in image sensor is output from the USB port to a PC for data acquisition. The C11118GA has sensitivity extending to longer wavelengths (up to 2.55 μ m) than the existing C9914GB (up to 2.2 μ m). The C11118GA comes with sample software for setting measurement conditions, acquiring and saving spectrum data, and displaying data graphs, as well as with the evaluation software and DLL.

Features

- **Spectral response range: 0.9 to 2.55 μm**
- **■** Compatible with USB 2.0 interface
- High throughput due to transmission grating made of guartz
- Highly accurate optical characteristics
- Low noise: cooled type
- Compact design for easy assembly
- Wavelength conversion factor *1 is recorded in internal memory
- Compatible with external trigger

- Applications
- Measurement of C-H group absorption (2.3 μm band)
- **■** Soil analysis and component analysis

Optical characteristics (Ta=25 °C)

Parameter	Specification	Unit
Spectral response range	0.9 to 2.55	μm
Spectral resolution (spectral response half width)*2	20 max.	nm
Wavelength reproducibility*3	-0.8 to +0.8	nm
Wavelength temperature dependence	-0.08 to +0.08	nm/°C
Spectral stray light*2 *4	-30 max.	dB

^{*2:} Depends on the slit opening. Values were measured with the slit listed in the table " == Structure/Absolute maximum ratings".

^{*1:} A conversion factor for converting the image sensor pixel number into a wavelength is recorded in the module.

A calculation factor for converting the A/D converted count into the input light intensity is not provided.

^{*3:} Measured under constant light input conditions, etc.

^{*4:} When monochromatic light of $\lambda=1700$ nm is input, spectral stray light is defined as the ratio of the count measured at the input wavelength, to the count measured at a wavelength 40 nm longer or shorter than the input wavelength.

■ Electrical characteristics (Ta=25 °C)

Parameter	Specification	Unit
A/D conversion	16	bits
Integration time*5	6 to 40000*6	μs
Interface	USB 2.0	-
USB bus power current consumption	250 max.	mA
Current consumption for cooling element (+5 V)*7	2.8 max.	Α
Current consumption for cooling fan (+12 V)*7	0.2 max.	Α

- *5: Depends on the image sensor dark current.
- *6: Excluding defective pixels
- *7: Maximum value in steady state. Note that inrush current flows at start-up.

Structure / Absolute maximum ratings

Parameter	Specification	Unit
Dimensions (W \times D \times H)	142 × 218 × 80	mm
Weight	1.7	kg
Image sensor	InGaAs linear image sensor (G9208-256W)	-
Number of pixels*8	256	pixels
Slit*9 (H × V)	140 × 250	μm
NA*10	0.22	-
Connector for optical fiber	SMA905D	-
Image sensor cooling temperature	-20	°C
Operating temperature*11	+5 to +35 (+5 to +30*12)	°C
Storage temperature*11	-20 to +70	°C

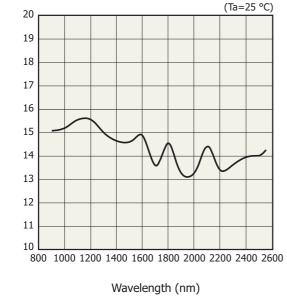
^{*8:} Up to 3 discontinuous defective pixels might exist (at low gain). Defective pixels are those whose electrical and optical characteristics do not meet our specifications.

- *9: Entrance slit aperture size
- *10: Numerical aperture (solid angle)
- *11: No condensation

Spectral resolution (nm)

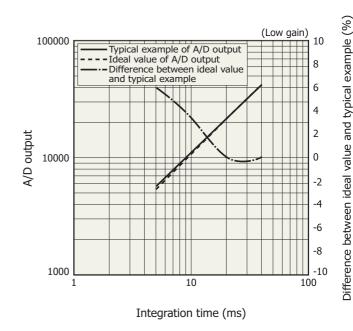
*12: Operating temperature capable of cooling control

Spectral resolution vs. wavelength (typical example)



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Linearity (typical example)

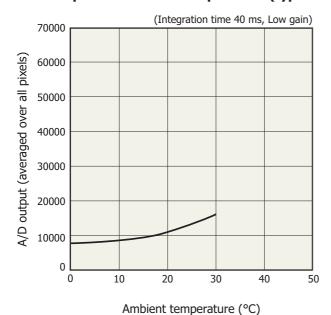


Note: A/D output is the output with dark output is subtracted when light is input. The difference between the ideal value and typical example contains a measurement error.

The smaller the A/D output, the larger the measurement error.



Dark output vs. ambient temperature (typical example)

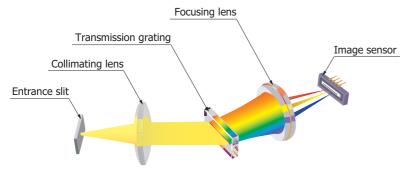


Note: A/D output is the sum of the sensor and circuit offset outputs and the sensor dark output.

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- Optical component layout

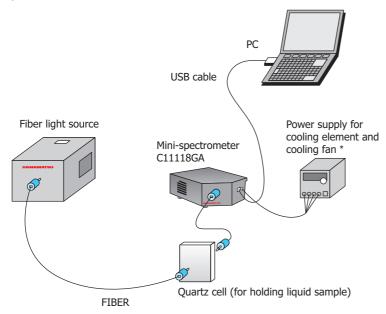
TG series mini-spectrometers use a transmission holographic grating made of quartz and precision optical components arranged on a rugged optical base, making it possible to deliver high throughput and highly accurate optical characteristics.



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Connection example (transmission light measurement)

Light to be measured is guided into the entrance port of TG series through an optical fiber and the spectrum measured with the builtin image sensor is output through the USB port to a PC for data acquisition. There are no moving parts inside the unit so stable measurements are obtained at all times. An optical fiber that guides light input from external sources allows a flexible measurement setup.



^{*} External power supply should be prepared by the user.

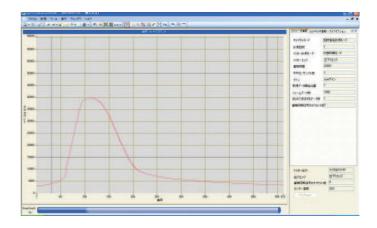
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Evaluation software (supplied with unit)

Installing the evaluation software (SpecEvaluationUSB2.exe)*13 into your PC allows running the following basic tasks:

- · Measurement data acquisition and save
- · Measurement condition setup
- · Module information acquisition (wavelength conversion factor, polychromator type, etc.)
- · Graphic display
- · Arithmetic function Pixel number to wavelength conversion Comparison calculation with reference data (transmittance, reflectance) Dark subtraction Gaussian approximation

(peak position and count, FWHM)



Note: Up to 8 mini-spectrometers can be connected and used with one PC.

*13: Compatible OS: Microsoft® Windows® XP Professional SP3 (32-bit)*14 Microsoft® Windows® Vista Business SP2 (32-bit)*14 Microsoft® Windows® 7 Ultimate SP1 (32-bit)*14 Microsoft® Windows® 7 Ultimate SP1 (64-bit)*14

DLL for controlling hardware is also provided.

You can develop your own measurement programs by using a following software development environment.

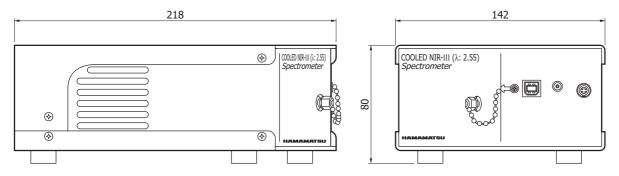
Microsoft® Visual Studio® 2008 (SP1) Visual C++®*14

Microsoft® Visual Studio® 2008 (SP1) Visual Basic®*14

*14: Microsoft, Windows, Visual Studio, Visual C++ and Visual Basic are either registerd trademarks or trademarks of Microsoft Corporation in the United States and other countries.



Dimensional outline (unit: mm, tolerance unless otherwise noted: ±0.5)



Weight: 1.7 kg

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Accessories

- · USB cable
- · Dedicated software (evaluation software, DLL)
- · Power supply connector for cooling element and cooling fan (FGG0B304CLAD56 made by LEMO S.A.)

Options (sold separately)

Type no.	Product name	Specification
A10670		1.5D-2V, Length 1.5 m Connector (one side) LEMO connector (FFA00S250 made by LEMO) BNC connector (BNC-P-1.5V-CR made by DDK)
A9763-01		Core diamater ϕ 600 µm, NA=0.22, Length 1.5 m Connector (both ends): SMA905D

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The C11118GA conforms to the European EMC directives (Applied standard: EN 61326-1 Class B).

Mini-spectrometer lineup

Type no		Tuna							Spe	ctral r	esp	ponse	rar	nge	(nr	n)							Spectral resolution	T	
Type no.		Туре	200) 4	00	600	8	00	1000	120	0	1400	160	00	180)Ó	2000	2	200	24	400	2600	max. (nm)	Image sensor	
C10082CA		TM-UV/VIS-CCD High sensitivity																					6	Back-thinned type	
C10082CAH		TM-UV/VIS-CCD High resolution		20	00 t	o 80	0																1*	CCD image sensor	
C10082MD	Se	TM-UV/VIS-MOS Wide dynamic range																					6	CMOS linear image sensor	
C10083CA	1 series	TM-VIS/NIR-CCD High sensitivity																					8 (λ=320 to 900 nm)	Back-thinned type	
C10083CAH	Σ	TM-VIS/NIR-CCD High resolution			2	20 to	10	00															1* (λ=320 to 900 nm)	CCD image sensor	
C10083MD		TM-VIS/NIR-MOS Wide dynamic range			ے.) 10																8	CMOS linear image sensor	
NEW C11697MA		TM-VIS/NIR-MOS-II Trigger-compatible																					8	CMOS image sensor with amp array	
C9404CA		TG-UV-CCD High sensitivity	20	10 to 401	1																		3	Back-thinned type CCD image sensor	
C9404CAH	Si	SS	TG-UV-CCD High resolution	20	יטיד טו טיסי	U																		1*	Back-thinned type CCD image sensor
NEW C9405CB	series	TG-SWNIR-CCD-II IR-enhanced				5(00 t	o 1	100														5 (λ=550 to 900 nm)	IR-enhanced back-thinned CCD image sensor	
NEW C11713CA	2	TG-RAMAN-I High resolution					500	to	600														0.3*	Back-thinned type CCD image sensor	
NEW C11714CA		TG-RAMAN-II High resolution							79	0 to 9	920	0											0.3*	Back-thinned type CCD image sensor	
C9406GC		TG-NIR Non-cooled type								900	t o	1700											7		
C9913GC	series	TG-cooled NIR-I Low noise (cooled type)																					7	InGaAs linear	
C9914GB	TG s	TG-cooled NIR-II Low noise (cooled type)										11	00	to	220	00							8	image sensor	
C11118GA		TG-cooled NIR-III Low noise (cooled type)											90	0 to	o 2!	55()						20		
C11007MA	series	RC-VIS-MOS Spectrometer module		(1)	340	to 7	80																9	CMOS linear image sensor	
C11008MA	RC s	RC-SWNIR-MOS Spectrometer module					640	to :	1050														8	IR-enhanced CMOS linear image sensor	

^{*} Typ.

For installation into	For installation into mobile measuring equipment																
Type no.		Туре	200	400	600	800				range 1600		2000	2200	2400	2600	Spectral resolution max. (nm)	Image sensor
C11009MA	eries	RC-VIS-MOS Spectrometer head		340	to 78	30										9	CMOS linear image sensor
C11010MA	RC se	RC-SWNIR-MOS Spectrometer head			6	40 to	1050									8	IR-enhanced CMOS linear image sensor

Ultra-compact type	Ultra-compact type for installation into mobile measuring equipment																
Type no.		Туре	200	400	600	800		ral res					2200	2400	2600	Spectral resolution max. (nm)	Image sensor
C10988MA	eries	MS-VIS-MOS Spectrometer head		340	to 75	0										14	CMOS linear
NEW C11708MA	MS se	MS-SWNIR-MOS Spectrometer head			6	40 to	1050									20	image sensor

Information described in this material is current as of January, 2012.

Product specifications are subject to change without prior notice due to improvements or other reasons. Before assembly into final products, please contact us for the delivery specification sheet to check the latest information.

Type numbers of products listed in the delivery specification sheets or supplied as samples may have a suffix "(X)" which means preliminary specifications or a suffix "(Z)" which means developmental specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use.

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